


ITEM NO.	DESCRIPTION	Material
1	Wafer 25x25 0.8mm pitch	FR4 Standard
2	Terminal Pin	Brass-PS-2

Description: Giga-snaP BGA SMT Land Socket

Primary dimension units are millimeters, Secondary dimension units are [inches], Weight is in grams.
 Tolerances: Hole diameters $\pm 0.0254\text{mm}$ [$\pm 0.001"$], Pitches (from true position) $\pm 0.0762\text{mm}$ [$\pm 0.003"$], substrate thickness tolerance $\pm 10\%$, all other tolerances $\pm 0.127\text{mm}$ [$\pm 0.005"$]
 unless stated otherwise. Materials and specifications are subject to change without notice.

LS-BGA624B-61 Specification  Ironwood Electronics, Inc. Tele: (800) 404-0204 www.ironwoodelectronics.com	Material: N/A Finish: N/A Weight: 1.94	STATUS: Released	SHEET: 1 OF 1	REV. A
		ENG: E. Smolentseva	DRAWN BY: M. Raske	SCALE: 4:1
		FILE: LS-BGA624B-61	DATE: 10/30/2013	